



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: JAMES L. VOELZ

APPLICATION No.: 10/687,096

FILED: OCTOBER 15, 2003

FOR: **METHODS FOR WAFER-LEVEL  
PACKAGING OF MICROELECTRONIC  
DEVICES AND MICROELECTRONIC  
DEVICES FORMED BY SUCH METHODS**

EXAMINER: SARA W. CRANE

ART UNIT: 2811

CONF. No: 7233

**Amendment Under 37 C.F.R. § 1.111**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The present communication responds to the Office Action dated April 20, 2005 in the above-identified application. A separate petition for a two-month extension and the requisite fee accompanies this amendment. Please amend the application as follows:

**Amendments to the Claims** are reflected in the listing of claims beginning on page 2.

**Remarks** begin on page 9 of this paper.